

#4/Election
4/15/03
C.P.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION

In re Application of:

Xiaoju Wu

Docket: TI-33227

Serial No.: 10/013,088

Art Unit: 2814

Filed: 12/07/2001

Examiner: A. Mai

For: METHOD OF MANUFACTURING AND STRUCTURE OF
SEMICONDUCTOR DEVICE WITH FIELD OXIDE STRUCTURE

FAX RECEIVED

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4-14-03

Jackie McBride
Jackie McBride

ELECTION

Sir:

In response to the Examiner's restriction requirement (Paper No. 3) mailed April 4, 2003, Applicant hereby elects to pursue Group II, Claims 10-18 for examination purposes.

Respectfully submitted,

Yingsheng Tung

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<table border="1"> <tr> <td colspan="2">NAME OF INVENTOR(S): Xiaoju Wu</td> <td colspan="2">RECEIPT DATE & SERIAL NO.: Serial No.: 10/013,088</td> </tr> <tr> <td colspan="2">TITLE OF INVENTION: Method of Manufacturing and Structure of Semiconductor Device with Field...</td> <td colspan="2">Filing Date: 12/07/2001</td> </tr> <tr> <td>TI FILE NO.: TI-33227</td> <td>DEPOSIT ACCT. NO.: 20-0668</td> <td colspan="2"></td> </tr> <tr> <td colspan="2">FAXED: 04/14/2003 DUE: 05/03/2003 ATTY/SEC'Y: YT/jsm</td> <td colspan="2"></td> </tr> </table>		NAME OF INVENTOR(S): Xiaoju Wu		RECEIPT DATE & SERIAL NO.: Serial No.: 10/013,088		TITLE OF INVENTION: Method of Manufacturing and Structure of Semiconductor Device with Field...		Filing Date: 12/07/2001		TI FILE NO.: TI-33227	DEPOSIT ACCT. NO.: 20-0668			FAXED: 04/14/2003 DUE: 05/03/2003 ATTY/SEC'Y: YT/jsm			
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